

Erratum

Liquid-Rubber-Modified Epoxy Adhesives Cured with Dicyandiamide. II.—Morphology and Adhesion Strengths

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Correct Table IV:

TABLE IV
Effect of Bisphenol A on the Lap Shear and T-Peel Strengths of Unmodified and Liquid Rubber Modified Epoxy Adhesives between Al–Al Joints

Sample no.	Bisphenol A (phr)	Liquid Rubber (phr)	Lap Shear strength (psi)	T-peel strength (pli)	T_g (°C)
2	0	0	2150 ± 100	11.7 ± 0.9	134
12	15	0	2700 ± 200	15.7 ± 0.9	105
9	0	10 (LR 2)	2450 ± 80	14.1 ± 2.0	114
13	15	10 (LR 2)	2770 ± 90	14.9 ± 0.8	105
7	0	10 (CTBN)	2520 ± 130	19.6 ± 1.1	102
14	15	10 (CTBN)	2940 ± 90	20.4 ± 2.4	92

Page 6330, the last line should read:

was put in an air-forced oven in a vertical position and dried at 60°C for 2 h.